TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

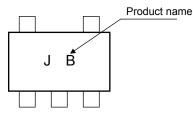
# TC7SZ125F,TC7SZ125FU

Bus Buffer 3-State Output

#### Features

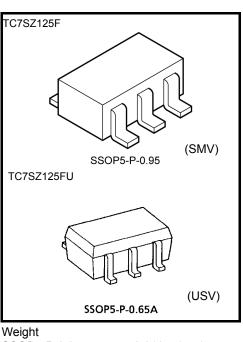
- High output current: ±24 mA (min) at V<sub>CC</sub> = 3 V
- Super high speed operation: t<sub>pd</sub> 2.6 ns (typ.) at V<sub>CC</sub> = 5 V, 50 pF
- Operation voltage range: V<sub>CC</sub> = 1.8 to 5.5 V
- 5.5-V tolerant inputs
- 5.5-V power down protection output
- Matches the performance of TC74LCX series when operated at 3.3 V  $V_{CC}.$

#### Marking



### Absolute Maximum Ratings (Ta = 25°C)

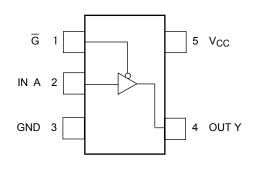
Characteristics	Symbol	Rating	Unit			
Supply voltage	V <sub>CC</sub>	–0.5 to 6	V			
DC input voltage	VIN	–0.5 to 6	V			
DC output voltage	Vour	–0.5 to 6 (Note 1)				
DC output voltage	Vout	-0.5 to Vcc+0.5 (Note 2)	V			
Input diode current	IIК	-20	mA			
Output diode current	I <sub>OK</sub>	-20(Note 3)	mA			
DC output current	IOUT	±50	mA			
DC V <sub>CC</sub> /ground current	ICC	±50	mA			
Power dissipation	PD	200	mW			
Storage temperature	T <sub>stg</sub>	–65 to 150	°C			
Lead temperature (10s)	ΤL	260	°C			



SSOP5-P-0.95 SSOP5-P-0.65A

: 0.016 g (typ.) : 0.006 g (typ.)

# Pin Assignment (top view)



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:  $V_{CC}$  = 0V or high impedance condition.

Note 2: High or Low state. Do not exceed  $\mathsf{I}_{\mathsf{OUT}}$  of absolute maximum ratings.

Note 3: V<sub>OUT</sub> < GND

# <u>TOSHIBA</u>

# **IEC Logic Symbol**



### **Truth Table**

Inp	out	Output				
А	IG	Y				
Х	Н	Z				
L	L	L				
Н	L	Н				

X: Don't Care Z: High Impedance

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	1.8 to 5.5	V
Supply voltage		1.5 to 5.5 (Note 4)	v
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 5)	V
		0 to V <sub>CC</sub> (Note 6)	v
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
	dt/dv	0 to 20 (V_{CC} = 1.8 V, 2.5 V $\pm$ 0.2 V)	
Input rise and fall time		0 to 10 (V_{CC} = 3.3 V $\pm$ 0.3 V)	ns/V
		0 to 5 (V_{CC} = 5.0 V $\pm$ 0.5 V)	

Note 4: Data retention only

Note 5:  $V_{CC} = 0 V$  or high impedance condition

Note 6: High or Low state

# **Electrical Characteristics**

#### **DC Characteristics**

Characteristics		Symbol	Symbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
Characteri			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit		
High level		VIH	—		1.8	V <sub>CC</sub> ×0.88		_	V <sub>CC</sub> ×0.88		
Input voltage	VН	2.3 to 5.5			V <sub>CC</sub> ×0.75		_	V <sub>CC</sub> ×0.75		- V	
				1.8	_		V <sub>CC</sub> ×0.12	_	V <sub>CC</sub> ×0.12		
	Low level	V <sub>IL</sub>			2.3 to 5.5	_		V <sub>CC</sub> ×0.25	_	V <sub>CC</sub> ×0.25	
					1.8	1.7	1.8	_	1.7		
		V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.3	2.2	2.3	_	2.2	_	
					3.0	2.9	3.0	—	2.9	_	
Hig	High level				4.5	4.4	4.5	_	4.4	_	- V
	rligirlevei	VОН		I <sub>OH</sub> = -8 mA	2.3	1.9	2.15		1.9	_	
				I <sub>OH</sub> = -16 mA	3.0	2.4	2.8	_	2.4	_	
				I <sub>OH</sub> = -24 mA	3.0	2.3	2.68	_	2.3	_	
Output voltage				I <sub>OH</sub> = -32 mA	4.5	3.8	4.2	—	3.8	_	
				I <sub>OL</sub> = 100 μΑ	1.8	—	0	0.1	—	0.1	
					2.3	—	0	0.1	_	0.1	
			DL VIN = VIL		3.0	—	0	0.1	_	0.1	
	l ow level	Low level V <sub>OL</sub>			4.5	—	0	0.1	_	0.1	
				I <sub>OL</sub> = 8 mA	2.3	—	0.1	0.3	—	0.3	
				I <sub>OL</sub> = 16 mA	3.0	—	0.15	0.4	—	0.4	
				I <sub>OL</sub> = 24 mA	3.0	—	0.22	0.55	—	0.55	
				I <sub>OL</sub> = 32 mA	4.5	—	0.22	0.55	—	0.55	
Input leakage curre	ent	I <sub>IN</sub>	$V_{IN} = 5.5 \text{ V or GND}$		0 to 5.5	—	_	±1	—	±10	μA
3-state output off-state current $I_{OZ}$ $V_{IN} = V_{IH}$ or $V_{I}$ $V_{OUT} = 0$ to 5.5			1.8 to 5.5		_	±1		±10	μA		
Power off leakage	ff leakage current I <sub>OFF</sub> V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V		T = 5.5 V = T	0.0			1		10	μA	
Quiescent supply c	urrent	ICC	$V_{IN} = V_{CC}$ or GND		5.5			2	—	20	μA

### AC Characteristics (unless otherwise specified, Input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Мах	Unit
	t <sub>pLH</sub>	$\begin{array}{l} C_L = 15 \ \text{pF}, \\ R_L = 1 \ M\Omega \\ (Figure 1 \ ) \end{array}$	1.8	2.0	5.3	11.0	2.0	11.5	
			$2.5\pm0.2$	0.8	3.4	7.5	0.8	8.0	ns
Dranssettion delay time			$\textbf{3.3}\pm\textbf{0.3}$	0.5	2.5	5.2	0.5	5.5	
Propagation delay time	t <sub>pHL</sub>		$5.0\pm0.5$	0.5	2.1	4.5	0.5	4.8	
		C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω (Figure 1 )	$\textbf{3.3}\pm\textbf{0.3}$	1.5	3.2	5.7	1.5	6.0	
			$5.0\pm0.5$	0.8	2.6	5.0	0.8	5.3	
	t <sub>pZL</sub> t <sub>pZH</sub>	$\begin{array}{l} C_L = 50 \ pF, \\ R_L = 500 \ \Omega \\ (Figure 1 \ ) \end{array}$	1.8	2.0	7.0	12.5	2.0	13.0	ns
Output enable time			$2.5\pm0.2$	1.5	4.6	8.5	1.5	9.0	
			$\textbf{3.3}\pm\textbf{0.3}$	1.5	3.5	6.2	1.5	6.5	
			$5.0\pm0.5$	0.8	2.8	5.5	0.8	5.8	
Output disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>	$\begin{array}{l} C_L = 50 \ pF, \\ R_L = 500 \ \Omega \\ (Figure 1 \ ) \end{array}$	1.8	2.0	5.4	11.0	2.0	12.0	ns
			$2.5\pm0.2$	1.5	3.5	8.0	1.5	8.5	
			$\textbf{3.3}\pm\textbf{0.3}$	1.0	2.8	5.7	1.0	6.0	
			$5.0\pm0.5$	0.5	2.1	4.7	0.5	5.0	
Input capacitance	C <sub>IN</sub>		0 to 5.5	_	4	_	_		pF
Power dissipation capacitance	C <sub>PD</sub>	(blat - 7)	3.3	_	17	_	_		nΕ
		(Note 7)	5.5	_	24	_	_		рF

Note 7: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:  $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

### **AC Characteristics Measurement Circuit**

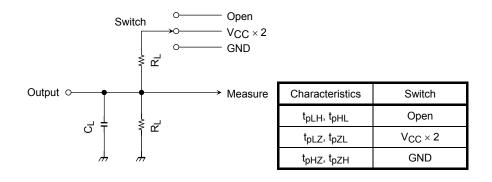


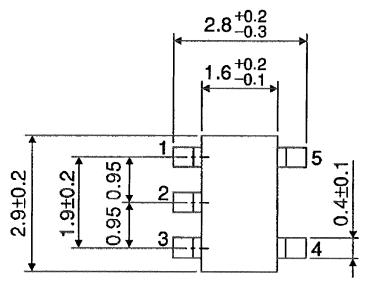
Figure 1

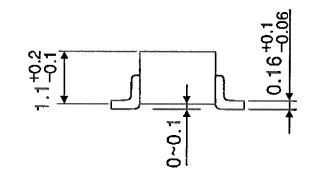
# <u>TOSHIBA</u>

# Package Dimensions

SSOP5-P-0.95

Unit : mm



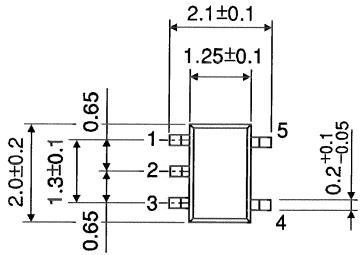


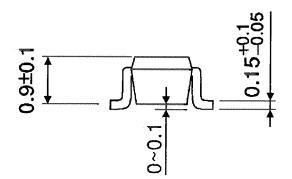
Weight: 0.016 g (typ.)

# <u>TOSHIBA</u>

# Package Dimensions

Unit : mm





Weight: 0.006 g (typ.)

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